				Docket Number (Optional)		Application Number		
OIP	INFO	RMATION DISCLOSURE	CITATION	FIS9200200 Applicant(s)	07	10/	605,204	
		:"	ליבי	Pogge et al.	•			
OCT 1 F	3003	• • • • • • • • • • • • • • • • • • •		Filing Date 09-15-03		Group Art Unit	282	1
EXAMINER-	, Qd		U.	S. PATENT DOCUMENTS			9.0	
EXAMINER-	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING	
						- 	IF APPRO	PRIATE
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			FO	REIGN PATENT DOCUMENTS				
	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Transl: YES	
							1 Ex	NO
	U a TAN							
						Date, Pertinent Pa		
AC		"Novel microelectronic Emery et al., Intel Corp.	packaging method for	r reduced thermomechanical st	resses on low (dielectric consta	nt material	s'',
	+	"Bridging the chip/pack	age process divide",	Pogge et al., IBM Microelectro	nics		*** *********************************	
AC								
EXAMINEI	R A	Tongo Chamb	leliss	DATE CONSIDERED	61	128/04	+	
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.					nce and			

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention

INTEGRATED ELECTRONIC CHIP AND INTERCONNECT DEVICE AND PROCESS FOR MAKING THE SAME

Application Number:

Confirmation Number:

First Named Applicant:

H. Pogge

Attorney Docket Number:

FIS920020007

Art Unit:

Examiner:

Search string:

(4670770 or 4783695 or 4884122 or 4933042 or 4949148 or 5019535 or 5353498

or 5373627 or 5998868 or 6025638 or 6066513 or 6087199 or 6110806 or 6444560

or 20020020924).pn

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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		2	4783695	1988-11-08	Eichelberger et			
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US Published Applications

Note: Applicant is n t required t submit a paper c py f cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
AC	1	20020020924	2002-02-21	Mueller et al.			

Signature

Examiner Name	Date
Alongo Chambus	6/28/04